To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

BIPOLAR ANALOG INTEGRATED CIRCUIT

μPC4741

HIGH PERFORMANCE QUAD OPERATIONAL AMPLIFIER

DESCRIPTION

The μPC4741 consists of four independent frequency compensated operational amplifiers featuring higher speed, broader band than general purpose type as 741. The μPC4741 is most appropriate for AC signal amplifier applications such as active filters or pulse amplifiers.

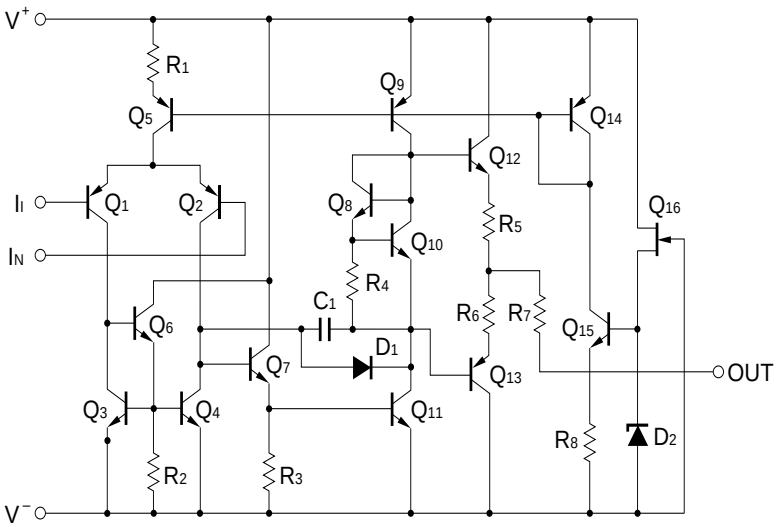
FEATURES

- Internal frequency compensation
- Low noise
- Output short circuit protection

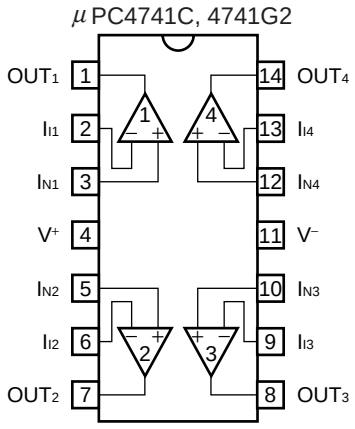
ORDERING INFORMATION

Part Number	Package
μPC4741C	14-pin plastic DIP (7.62 mm (300))
μPC4741C(5)	14-pin plastic DIP (7.62 mm (300))
μPC4741G2	14-pin plastic SOP (5.72 mm (225))
μPC4741G2(5)	14-pin plastic SOP (5.72 mm (225))

EQUIVALENT CIRCUIT (1/4 Circuit)



PIN CONFIGURATION (Top View)



Document No. G16051EJ4V0DS00 (4th edition)
Date Published March 2004 N CP(K)
Printed in Japan

The mark ★ shows major revised points.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Parameter		Symbol	Ratings	Unit
Voltage between V^+ and V^- Note1		$V^+ - V^-$	–0.3 to +40	V
Differential Input Voltage		V_{ID}	±30	V
Input Voltage Note2		V_I	V^-–0.3 to V^+ +0.3	V
Output Voltage Note3		V_O	V^-–0.3 to V^+ +0.3	V
Power Dissipation	C Package Note4	P_T	570	mW
	G2 Package Note5		550	mW
Output Short Circuit Duration Note6			10	sec
Operating Ambient Temperature		T_A	–20 to +80	°C
Storage Temperature		T_{stg}	–55 to +125	°C

Notes 1. Reverse connection of supply voltage can cause destruction.

2. The input voltage should be allowed to input without damage or destruction. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The normal operation will establish when the both inputs are within the Common Mode Input Voltage Range of electrical characteristics.

3. This specification is the voltage which should be allowed to supply to the output terminal from external without damage or destructive. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The output voltage of normal operation will be the Output Voltage Swing of electrical characteristics.

4. Thermal derating factor is –7.6 mW/°C when ambient temperature is higher than 50°C.

5. Thermal derating factor is –5.5 mW/°C when ambient temperature is higher than 25°C.

6. Pay careful attention to the total power dissipation not to exceed the absolute maximum ratings, Note 4 and Note 5.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	$V^{\pm}$	±4		±16	V

μPC4741C, 4741G2

ELECTRICAL CHARACTERISTICS (T_A = 25°C, $V^{\pm}$ = ±15 V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input Offset Voltage	V_{IO}	$R_S \leq 100\ \Omega$		±1.0	±5.0	mV
Input Offset Current [Note]	I_{IO}			±30	±50	nA
Input Bias Current [Note]	I_B			70	300	nA
Large Signal Voltage Gain	A_V	$R_L \geq 2\ k\Omega$, V_O = ±10 V	25,000	50,000		
★ Power Consumption	Pd	I_O = 0 A		150	210	mW
Common Mode Rejection Ratio	CMR		80	100		dB
Supply Voltage Rejection Ratio	SVR			50	100	μV/ V
Maximum Output Voltage	V_{om}	$R_L \geq 10\ k\Omega$	±12	±13.7		V
Maximum Output Voltage	V_{om}	$R_L \geq 2\ k\Omega$	±10	±12.5		V
Common Mode Input Voltage Range	V_{ICM}		±12	±14		V
Slew Rate	SR	A_V = 1		1.6		V/ μs
Input Equivalent Noise Voltage Density	e_n	f = 1 kHz		9		$nV/\sqrt{Hz}$
Channel Separation		f = 10 kHz		108		dB

Note Input bias currents flow out from IC. Because each currents are base current of PNP-transistor on input stage.

μPC4741C (5), 4741G2 (5)

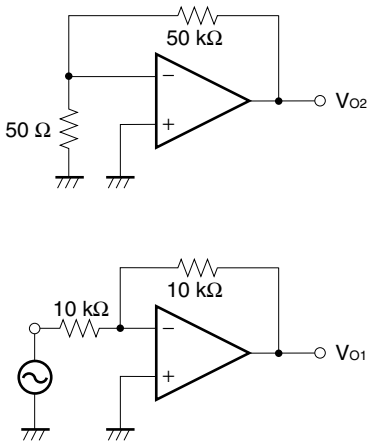
ELECTRICAL CHARACTERISTICS (T_A = 25°C, $V^{\pm}$ = ±15 V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input Offset Voltage	V_{IO}	$R_S \leq 100\ \Omega$		±1.0	±2.0	mV
Input Offset Current [Note]	I_{IO}			±30	±50	nA
Input Bias Current [Note]	I_B				100	nA
Large Signal Voltage Gain	A_V	$R_L \geq 2\ k\Omega$, V_O = ±10 V	28,000	50,000		
★ Power Consumption	Pd	I_O = 0 A		150	210	mW
Common Mode Rejection Ratio	CMR		85	90		dB
Supply Voltage Rejection Ratio	SVR				50	μV/ V
Maximum Output Voltage	V_{om}	$R_L \geq 10\ k\Omega$	±12.5	±13.7		V
Maximum Output Voltage	V_{om}	$R_L \geq 2\ k\Omega$	±11	±12.5		V
Common Mode Input Voltage Range	V_{ICM}		±13	±14		V
Slew Rate	SR	A_V = 1		1.6		V/ μs
Input Equivalent Noise Voltage Density	e_n	f = 1 kHz		9		$nV/\sqrt{Hz}$
Channel Separation		f = 10 kHz		108		dB

Note Input bias currents flow out from IC. Because each currents are base current of PNP-transistor on input stage.

MEASUREMENT CIRCUIT

Fig.1 Channel Separation Measurement Circuit

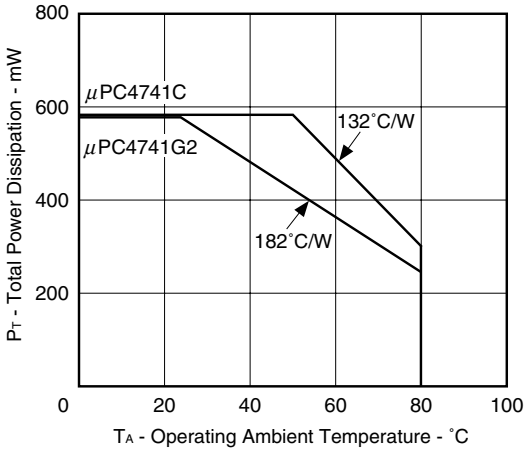


Channel Separation

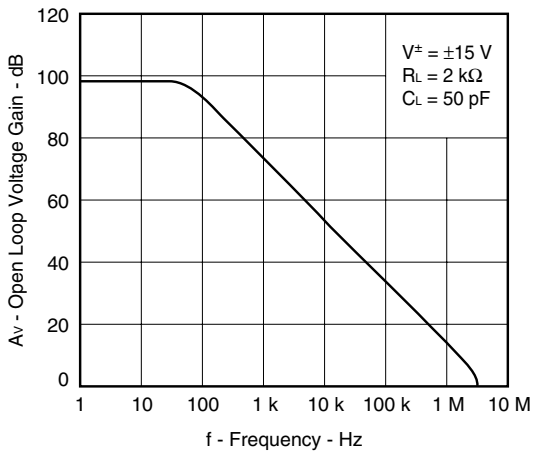
$$= \left| 20 \cdot \log \left(\frac{1}{1000} \cdot \frac{V_{O2}}{V_{O1}} \right) \right|$$

TYPICAL PERFORMANCE CHARACTERISTICS (T_A = 25°C, TYP.)

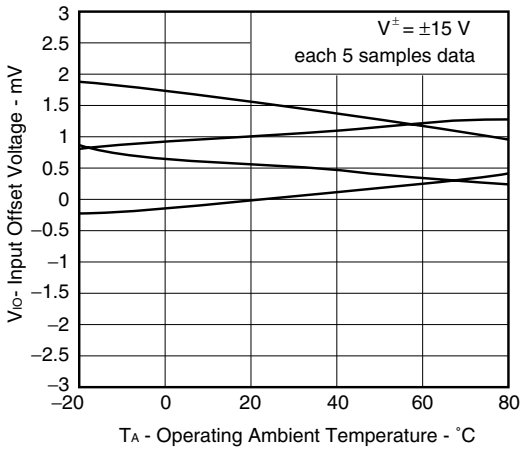
POWER DISSIPATION



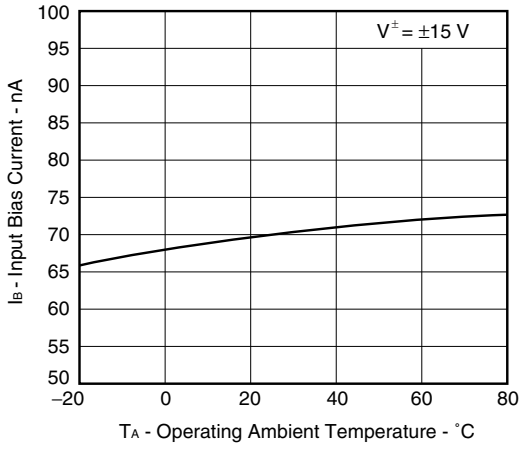
OPEN LOOP FREQUENCY RESPONSE



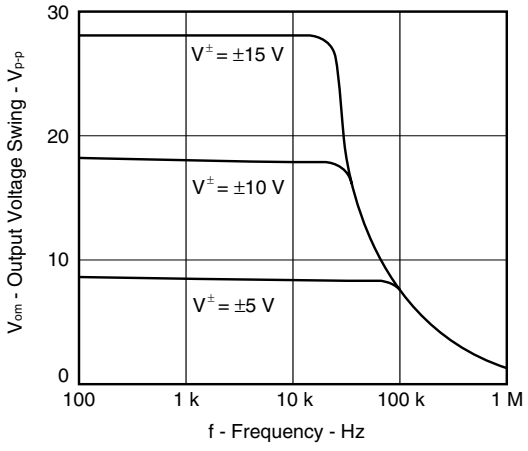
★ INPUT OFFSET VOLTAGE



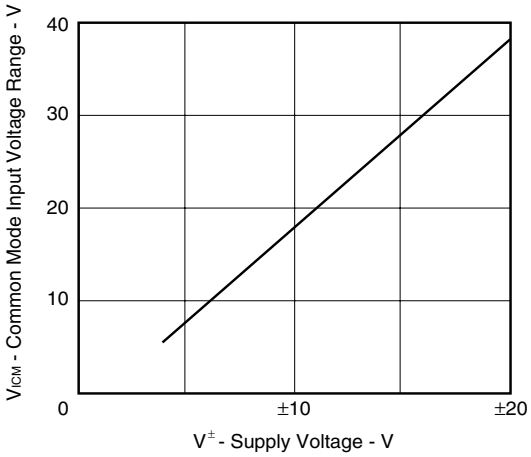
INPUT BIAS CURRENT



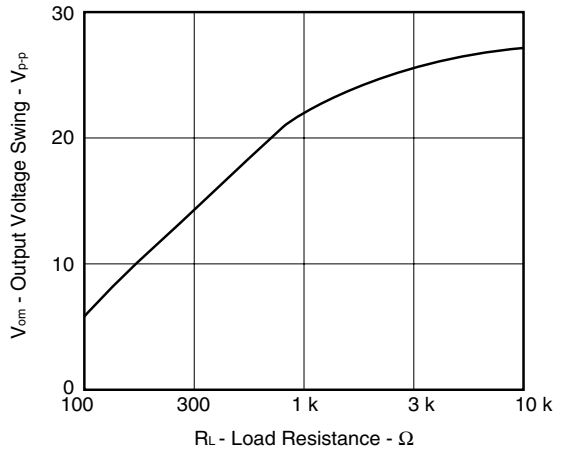
LARGE SIGNAL FREQUENCY RESPONSE



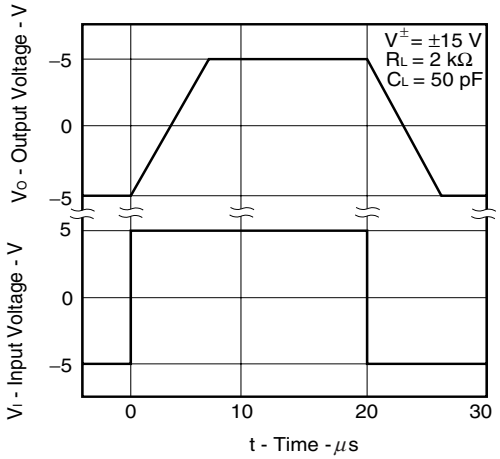
COMMON MODE INPUT VOLTAGE RANGE



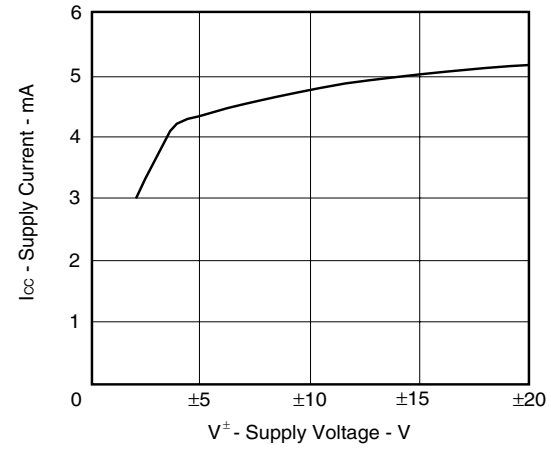
OUTPUT VOLTAGE SWING



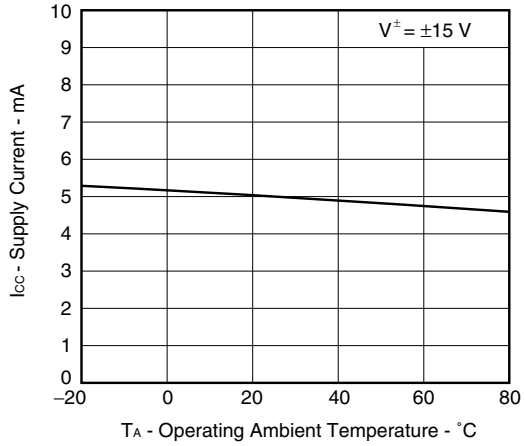
VOLTAGE FOLLOWER PULSE RESPONSE



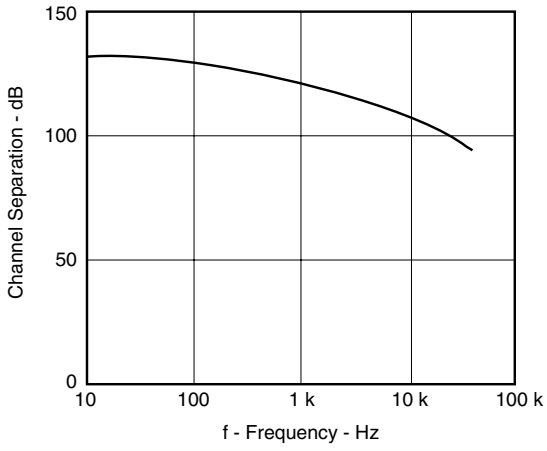
SUPPLY CURRENT



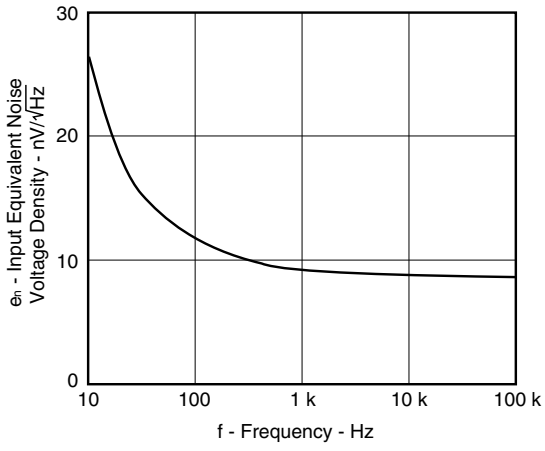
SUPPLY CURRENT



CHANNEL SEPARATION

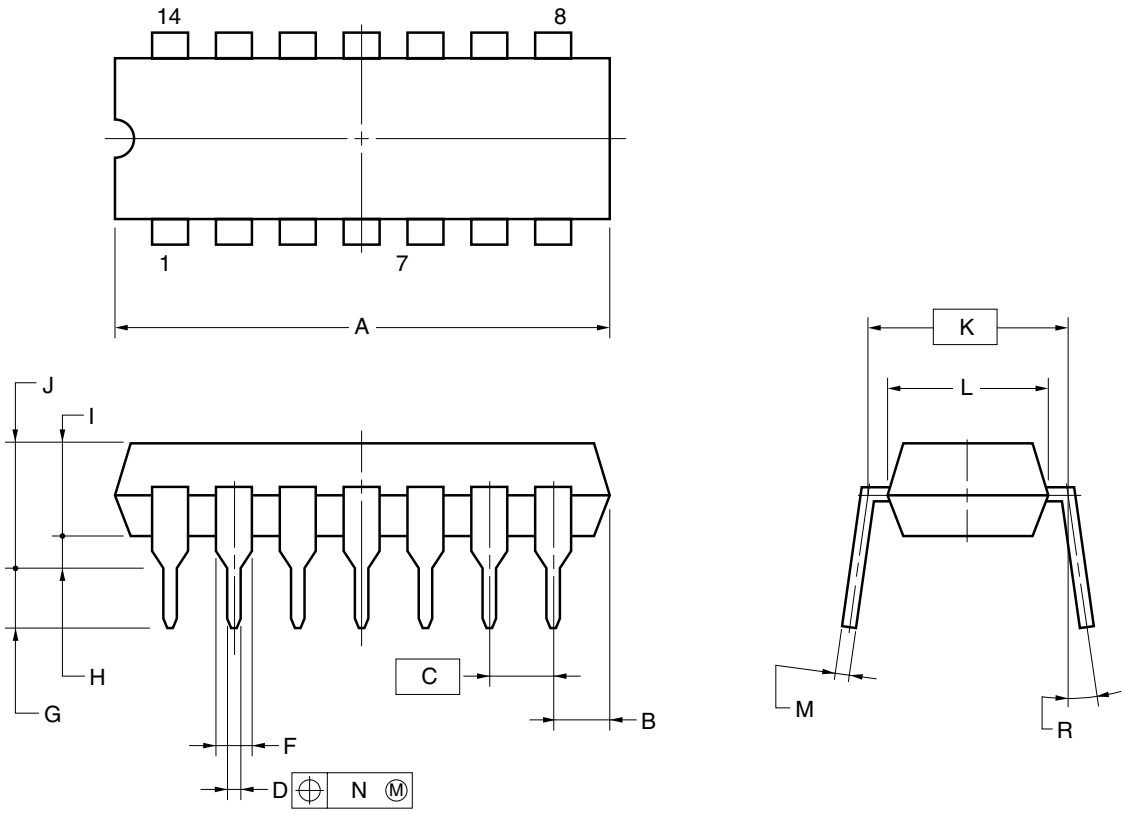


INPUT EQUIVALENT NOISE VOLTAGE DENSITY



PACKAGE DRAWINGS (Unit: mm)

14-PIN PLASTIC DIP (7.62 mm (300))



NOTES

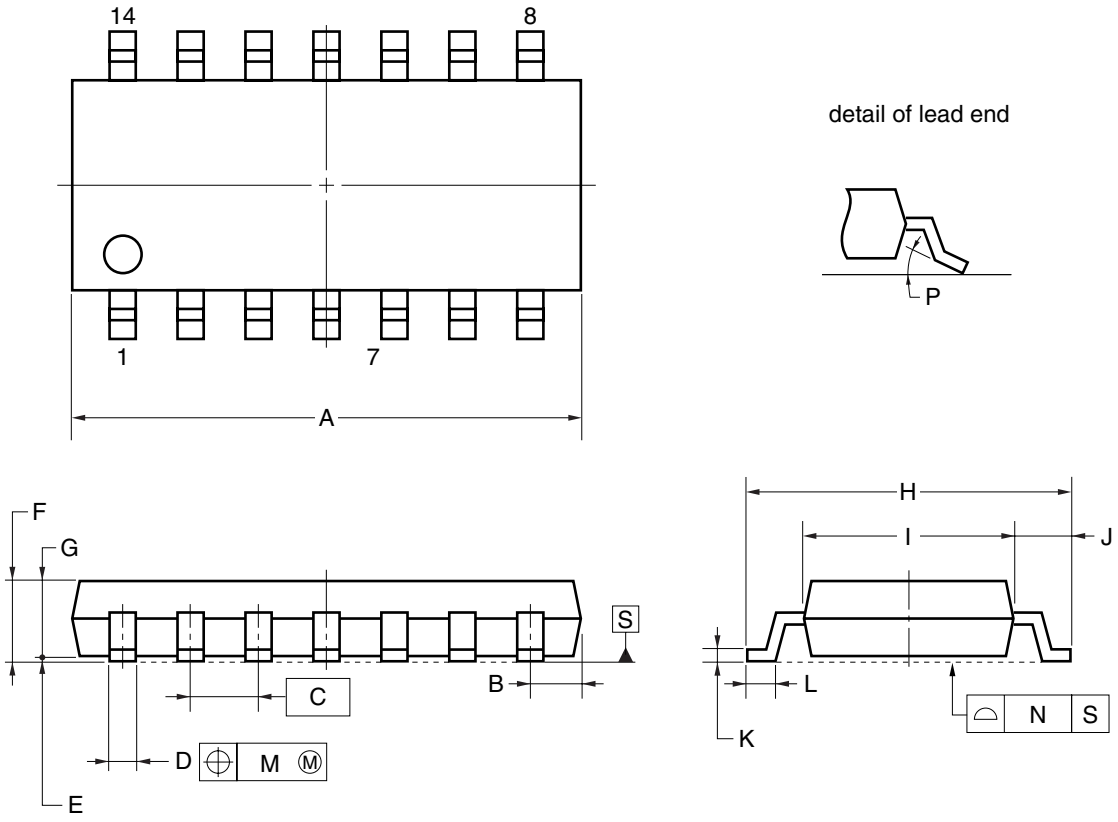
1. Each lead centerline is located within 0.25 mm of its true position (T.P.) at maximum material condition.

2. Item "K" to center of leads when formed parallel.

ITEM	MILLIMETERS
A	19.22±0.2
B	2.14 MAX.
C	2.54 (T.P.)
D	0.50±0.10
F	1.32±0.12
G	3.6±0.3
H	0.51 MIN.
I	3.55
J	4.3±0.2
K	7.62 (T.P.)
L	6.4±0.2
M	$0.25^{+0.10}_{-0.05}$
N	0.25
R	0~15°

P14C-100-300B1-3

14-PIN PLASTIC SOP (5.72 mm (225))



NOTE

Each lead centerline is located within 0.1 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
A	10.2±0.26
B	1.42 MAX.
C	1.27 (T.P.)
D	$0.42^{+0.08}_{-0.07}$
E	0.1±0.1
F	$1.59^{+0.21}_{-0.2}$
G	1.49
H	6.5±0.2
I	4.4±0.1
J	1.1±0.16
K	$0.17^{+0.08}_{-0.07}$
L	0.6±0.2
M	0.1
N	0.10
P	$3^{\circ}{}^{+7^{\circ}}_{-3^{\circ}}$

S14GM-50-225B, C-6

★ RECOMMENDED SOLDERING CONDITIONS

The μPC4741 should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Type of Surface Mount Device

μPC4741G2, 4741G2(5): 14-pin plastic SOP (5.72 mm (225))

Process	Conditions	Symbol
Infrared Ray Reflow	Peak temperature: 235°C or below (Package surface temperature), Reflow time: 30 seconds or less (at 210°C or higher), Maximum number of reflow processes: 3 time.	IR35-00-3
Vapor Phase Soldering	Peak temperature: 215°C or below (Package surface temperature), Reflow time: 40 seconds or less (at 200°C or higher), Maximum number of reflow processes: 3 time.	VP15-00-3
Wave Soldering	Solder temperature: 260°C or below, Flow time: 10 seconds or less, Maximum number of flow processes: 1 time, Pre-heating temperature: 120°C or below (Package surface temperature).	WS60-00-1
Partial Heating Method	Pin temperature: 300°C or below, Heat time: 3 seconds or less (Per each side of the device).	–

Caution Apply only one kind of soldering condition to a device, except for "partial heating method", or the device will be damaged by heat stress.

Type of Through-hole Device

μPC4741C, 4741C(5): 14-pin plastic DIP (7.62 mm (300))

Process	Conditions
Wave Soldering (only to leads)	Solder temperature: 260°C or below, Flow time: 10 seconds or less.
Partial Heating Method	Pin temperature: 300°C or below, Heat time: 3 seconds or less (per each lead).

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

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